

Docket No.: 50432-528 (G1120)



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

|  |   |                                    |
|--|---|------------------------------------|
| In re Application of                               | : | <b>RESPONSE UNDER 37 CFR 1.116</b> |
|  | : | <b><u>EXPEDITED PROCEDURE</u></b>  |
| Darin CHAN, et al.                                 | : |                                    |
|  | : | Customer Number: 20277             |
| Application No.: 10/023,350                        | : | Confirmation Number: 5761          |
|  | : | Group Art Unit: 2818               |
| Filed: December 20, 2001                           | : | Examiner: D. Nguyen                |
|  | : |                                    |
| For: SOI DEVICE WITH DIFFERENT SILICON THICKNESSES | : |                                    |

**AMENDMENT UNDER 37 C.F.R. § 1.116**

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The following Amendment and Remarks are submitted in response to the Final Office

Action dated September 3, 2003, pursuant to the provisions of 37 C.F.R. § 1.116.